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Thermosense: Thermal Infrared Applications XXXIX

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Douglas Burleigh
Editors

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Introduction

The Thermosense conference continues to play a significant role in assessing the state-of-the-art, current developments, and future trends in the applications of infrared thermography.

This year, for the first time, Thermosense was held in Anaheim, California (United States), on 9–13 April, 2017.

The international Thermosense community of academic scientists, industry professionals, and students submitted 62 abstracts and made 46 presentations. Countries represented this year included Argentina, Canada, India, Japan, Mexico, Russia, Tajikistan, and the United States, along with a contingent of researchers from European countries including Austria, Belgium, France, Germany, Italy, and the United Kingdom.

Two awards were presented for excellence in scientific achievement. The first award, for the best overall paper, involved the use of IR thermography in large scale applications: the study of buildings and infrastructures. The second was for the best student paper, which involved small/micro scale applications: the study of thermal/mechanical properties of materials.

The awards were sponsored by FLIR Systems Inc. and IRCameras LLC respectively. These two award-winning papers demonstrated the wide range of flexibility of infrared technology.

Other topics of growing interest represented at this year’s Thermosense were the use of thermography in additive manufacturing, in biological and medical applications, and in the ever-growing application of nondestructive testing (NDT).

Thermosense promotes developments in infrared technology by hosting the annual “Vendor” session, which is now in its 13th year. This very popular session is a unique opportunity for people to learn about new equipment, systems, and accessories.

Next year the historic 40th (XL) Thermosense conference will be held in Orlando, Florida (United States) where most of our conferences have been. Many of our dedicated group have been coming to Thermosense for 20–30 years, and a small number attended Thermosense 1.

We will plan some special events for Thermosense XL.

Paolo Bison
Douglas Burleigh